



Product Change Notification

Change Notification #: 116388 - 00

Change Title: Intel® Platform Controller Hub: FH82B360, FH82C242, FH82C246, FH82CM246, FH82H310, FH82H310, FH82H370, FH82HM370, FH82Q370, FH82QM370, PCN 116388-00, Manufacturing Site, Label, Notification to Customers that the Intel products will have Sub-Mark only or Assembly in CDAT, China and Post Sub-mark Assembly, test, and finish in VNAT, Vietnam

Date of Publication: August 01, 2018

Key Characteristics of the Change:

Manufacturing Site, Label

Forecasted Key Milestones:

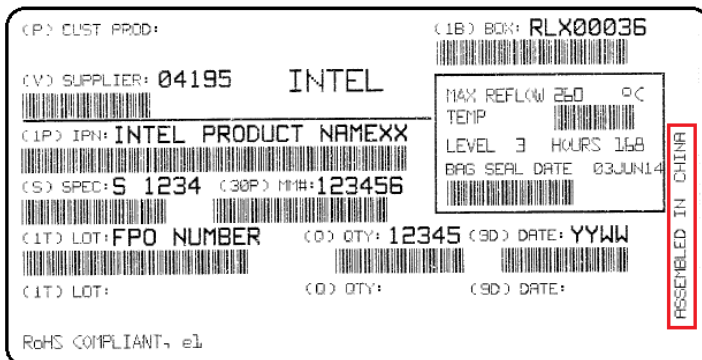
Date Customer Must be Ready to Receive Post-Conversion Material:	August 16, 2018
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Description of Change to the Customer:

In order to ensure a continuous supply of the Intel® Controller Hubs products listed in the "Products Affected" Table below, Intel will be using the Sub-mark process capabilities in CDAT in China and complete the assembly, test and finish process in VNAT, Vietnam. In addition Intel will be also be using the assembly process capabilities in CDAT in China and complete the test and finish process in VNAT, Vietnam.

As part of this change, after CDAT starts the assembly manufacturing process (sub-mark laser and/or assembly), the parts/materials will be shipped to VNAT wherein VNAT will complete the Assembly Process (if not done in CDAT). VNAT will then do the Test and Finish. As a result of this assembly plan, customers will see the country of origin on labels display the value for China when in fact, VNAT will be the site that finishes the assembly portion of the manufacturing process.

Country of Origin label example:



Both CDAT and VNAT sites have already been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers for this change. Customers may contact their Intel Field Sales Representative or the contacts listed on the first page of this Product Change Notification appropriate to your geo with questions.

Fabrication (Fab), sort, and assembly test facilities follow a Copy Exactly! (CE!) philosophy. Copy Exactly! enables delivery of product from multiple production sites, which operate as a virtual factory that performs consistently and independent of the manufacturing source site. Additional benefits include faster production ramps that improve product availability and improved consistency to quality performance.

Learn more about CE! At <http://www.intel.com/content/www/us/en/quality/exact-copy.html> web site.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#
Intel® FH82B360 Platform Controller Hub.	FH82B360	S R408	964265
Intel® FH82C242 Platform Controller Hub	FH82C242	S R40C	964270
Intel® FH82C246 Platform Controller Hub.	FH82C246	S R40A	964268
Intel® FH82CM246 Platform Controller Hub	FH82CM246	S R40E	964272
Intel® FH82H310 Platform Controller Hub.	FH82H310	S R409	964267
Intel® FH82H310 Platform Controller Hub	FH82H310	S RCXY	978829
Intel® FH82H370 Platform Controller Hub.	FH82H370	S R405	964247
Intel® FH82HM370 Platform Controller Hub	FH82HM370	S R40B	964269
Intel® FH82Q370 Platform Controller Hub.	FH82Q370	S R404	964246
Intel® FH82QM370 Platform Controller Hub	FH82QM370	S R40D	964271

PCN Revision History:

Date of Revision:

August 1, 2018

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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